



(0,635 mm) .025"

QFS-PC, QFS-RF SERIES

HIGH SPEED COMBO RF & POWER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?QFS

Insulator Material: Liquid Crystal Polymer
Contact & Ground Plane Material: Phosphor Bronze

Plating:
Au over 50µ" (1,27 µm) Ni (Tin on Ground Plane Tail)
Current Rating: Signal Contact: 2.6 A per pin
(1 pin powered per row)
Power Contact: 4.0 A per pin (4 pins powered per end) Ground Plane: 15.7 A per ground plane (1 ground plane powered) Voltage Rating: 300 VAC mated with QMS Operating Temp: -55°C to +125°C

RoHS Compliant: Processing:

Lead-Free Solderable:

SMT Lead Coplanarity: (0,10 mm) .004" max (026-078) **Board Stacking:**

For applications requiring more than two connectors per board, contact ipg@samtec.com

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



ALSO AVAILABLE (MOQ Required)

- Other platings
- Differential Pairs
- Retention Pins
- 8 Power Pins/End for (1,60 mm) .062" thick Board
- 4 or 8 Power Pins/End for (2,36 mm) .093" thick Board
- 2 RF Connectors/End
- Hot Pluggable Contact Samtec.

Note: Some lengths, styles and options are non-standard, non-returnable.

Board Mates:

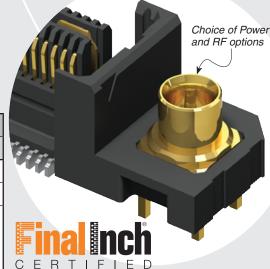
QMS-PC, QMS-RA-PC,

QMS-PC/QFS-PC 10 mm Stack Height	Туре	Rated @ 3dB Insertion Loss	
		with PCB effects*	w/o PCB effects**
Single-Ended	-D	9 GHz /	8.5 GHz /
Signaling		18 Gbps	17 Gbps
Differential Pair	-D	8 GHz /	8.5 GHz /
Signaling		16 Gbps	17 Gbps

*Performance data includes effects of a non-optimized PCB.

Test board losses de-embedded from performance data.

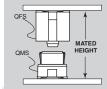
Performance data for other stack heights and complete test data available at www.samtec.com?QFS or contact sig@samtec.com



SAMTEC

- Increased insertion depth
- · Integral guide post

APPLICATION



QMS LEAD STYLE	MATED HEIGHT*	
-05.75	10 mm	
-06.75	11 mm	
*Processing conditions will affect mated height		

NO. OF PINS **PER ROW** ·026, -052, -078 (52 total pins per bank)

STYLE OPTION 04.25 <u>=04.25</u> mm

PLATING

LEAD

= 10μ" (0,25 μm) Gold on Signal Pins and Ground Plane

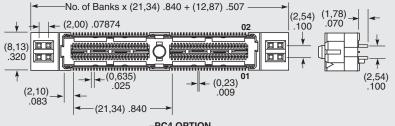
> (Tin on Signal Pin tails, and Ground Plane tails)

OPTION

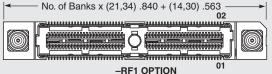
END

-PC4 = 4 Power Pins per End for (1,60 mm) .062" thick Board (N/A with –RF1)

-RF1 = One RF Jack per End (N/A with -PC4)



-PC4 OPTION



.070 (3,56) .028 .140 DIA

(1,78)



OTHER

See SO Series for precision machined standoffs.